

Optimizing Communications and I/O on Aurora for Application Performance

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Argonne in a la sorator





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The Argonne Leadership Computing Facility provides world-class computing resources to the scientific community.

- Users pursue scientific challenges
- In-house experts to help maximize results
- Resources fully dedicated to open science





ALCF offers different pipelines for different applications



EARNING

Architecture supports three types of computing

- Large-scale Simulation
 (PDEs, traditional HPC)
- Data Intensive Applications (scalable science pipelines)
- Deep Learning and Emerging Science AI (training and inferencing)







Intel GPU Intel[®] Data Center GPU Max Series

Intel Xeon Processor 4th Gen Intel XEON Max Series CPU with High Bandwidth Memory

Platform HPE Cray-Ex Racks - 166 Nodes - 10,624 CPUs - 21,248 GPUs - 63,744

Interconnect

HPE Slingshot 11 Dragonfly topology with adaptive routing Network Switch:

25.6 Tb/s per switch (64 200 Gb/s ports) Links with 25 GB/s per direction

Platform

HPE Cray-EX

Peak FP Performance **≥ 2 Exaflops DP**

Memory

10.9PB of DDR @ 5.95 PB/s 1.36PB of CPU HBM @ 30.5 PB/s 8.16PB of GPU HBM @ 208.9 PB/s

Network

2.12 PB/s Peak Injection BW 0.69 PB/s Peak Bisection BW

Storage 230PB DAOS Capacity 31 TB/s DAOS Bandwidth

Current Status of Aurora

- All of the Aurora hardware is installed at ANL
- Aurora deployment and testing is underway
- Early users have access to the system and are running applications at limited scale









Aurora Exascale Compute Blade

NODE CHARACTERISTICS

- 6 GPUs Intel Data Center GPU Max Series
- 2 CPUs Intel Xeon CPU Max Series

768 GB GPU HBM Memory

19.66 TB/s Peak GPU HBM BW

128 GB CPU HBM Memory

2.87 TB/s Peak CPU HBM BW

1024 GB CPU DDR5 Memory

0.56 TB/s Peak CPU DDR5 BW

≥ 130 TF Peak Node DP FLOPS

200 GB/s Max Fabric Injection

8 NICs - HPE Slingshot 200G







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4th Gen Intel® Xeon Max Series CPU with HBM (Sapphire Rapids)

XEON DESCRIPTION	
Cores	52
Vector Extension	AVX-512
Threads (#)	2
Total HBM Memory (GB)	64
Peak HBM Memory BW (TB/s)	1.43
Total DDR5 4400 Memory (GB)	512
Peak DDR5 4400 Memory BW (TB/s)	0.28





HPE Slingshot Interconnect

Consistent, Repeatable Application Performance

- Advanced congestion control
- Fine grained adaptive routing
- Very low average and tail latency

Extremely Scalable RDMA Performance

- Connectionless protocol
- Fine grained flow control
- MPI HW tag matching & progress engine
- Dragonfly topology 3 switch hops (typical)

Native Ethernet

- Native IP no encapsulation
- High-scale bandwidth integration to campus

HPE Slingshot Switches - 64 ports @ 200 Gbps **HPE Switch ASIC Rack switches** 100% DLC Switches **HPE Slingshot NICs - 200 Gbps** HPE NIC ASIC 100% DLC NIC Mezz **PCIe Adapters**



Fabric



- 1-D Dragonfly Topology 175 total groups (166 compute + 8 IO + 1 Service),
- All the global links are optical, all the local links in compute groups are electrical
- 2 global links between any two compute groups
- 24 links between any two IO groups, 8 links between the Service group and each IO group



MPI Benchmark Results

- Bisection
 - —9759 nodes
 - -8 ranks per node or 1 rank per NIC
 - -78,072 Slingshot endpoints
 - —1 MiB message size
 - -Aggregate BW 357036.51 GB/sec
- MPI_All2all
 - —9758 nodes
 - -8 ranks per node
 - —64K message size
 - —Aggregate BW 141683.50 GB/sec

- OSU Pairs
 - —9758 nodes
 - -8 ranks per node
 - —4K message size
 - —Aggregate messages/s 59,826,805,718.19



MPI node configuration

- Aurora has 8 NICs per node and 2 CPU sockets per node
 - -MPICH selects NIC to use based on affinity and NUMA distance
 - -Distribute ranks between both sockets to use all NICs
 - -Set CPU binding to get best performance
- Libfabric and MPICH have many tuneables
 - -These are often set to conservative values to reduce resource usage in default modes
 - -Setting values higher may improve performance for some/many workloads
 - -https://docs.alcf.anl.gov/aurora/known-issues/
 - —export FI_CXI_DEFAULT_CQ_SIZE=131072
 - —export FI_CXI_OVFLOW_BUF_SIZE=8388608
 - —export FI_CXI_CQ_FILL_PERCENT=50
- Multi-NIC striping
 - When using few ranks than NICs, multi-NIC striping breaks messages and sends data across multiple NICs from a single process
 - https://www.mpich.org/static/docs/slides/2021-sc-bof/Intel.pdf
 - export MPIR_CVAR_CH4_OFI_ENABLE_MULTI_NIC_STRIPING=1 (or 0 to turn off)
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Aurora Storage Systems

- Aurora will have multiple storage systems:
 - —DAOS: provides Aurora's main "platform" high performance storage system
 - -Lustre: will utilize existing ALCF systems (Grand, Eagle) for center-wide data access and data sharing
- DAOS is a novel file system architecture the provides:
 - -A flexible storage API that enables new I/O paradigms
 - -Compatibility with existing I/O models such as POSIX, MPI-IO and HDF5
 - -Open source storage solution

System	Capacity	Performance
Aurora DAOS	 220 PB @ EC16+2 250 PB NVMe 8 PB Optane PMEM 	31 TB/s Read & Write
Eagle	100 PB @ RAID6	> 650 GB/s Read & Write
Grand	100 PB @ RAID6	> 650 GB/s Read & Write





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The Aurora open-source storage strategy strongly favors cooperation:

- DAOS: object storage system for in-fabric high-performance platform storage (the first of its kind on a DOE leadership system!)
- Lustre: parallel file systems for facility-wide access and data sharing Namespace integration will make it easier for users to manage data.

•1024 DAOS server nodes, each with:

- -16 x 512GB persistent memory
- —16 x 15.3TB NVMe drives
- -2 x HPE Slingshot NICs
- Dual CPU with 512 GB RAM



IO-500 results (SC'23)

• RF0

-[RESULT] -[RESULT]

-[RESULT]

-[RESULT]

ior-easy-write21029.853648 GiB/sior-hard-write10500.042182 GiB/sior-easy-read11890.364024 GiB/sior-hard-read6348.025367 GiB/s

• RF1

—[RES	ULT]
—[RES	ULT]
—[RES	ULT]
—[RES	ULT]

ior-easy-write20693.627959 GiB/sior-hard-write4216.340094 GiB/sior-easy-read12122.872205 GiB/sior-hard-read9706.548821 GiB/s

- RF1 configuration
 - EC_16P1GX ior easy
 - RP_2GX ior hard
 - RP_2G1 for mdtest files
 - RP_2GX for mdtest hard dir
 - RP_2G32 for mdtest easy dir
- 300 Aurora compute nodes
 - 18 compute groups
- 642 DAOS servers
 - 8 DAOS groups



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- 2 global links between any two compute groups
- 24 links between any two IO groups, 8 links between the Service group and each IO group
- Total injection bandwidth: 2.12PB/s
- Total bisection bandwidth: 0.69PB/s



IO Performance

- Larger number of client nodes increases performance
- DAOS needs reasonable number of ranks per node to achieve ideal performance
 - More ranks per node for efficient single node performance
 - At scale, even inefficient I/O configuration will still saturate
- Distribute I/O process (like MPI) over both sockets to take advantage of all NICs
 - —DAOS specifically selects NICs in a round-robin fashion based on NUMA



Data from 20 DAOS node configuration Courtesy of Rob Latham (Argonne)



Aurora Applications



Aurora Applications Overview

- Early applications for Aurora come from two programs:
 - —The Argonne Early Science Program (ESP) : 19 projects
 - 9 Simulation projects
 - 5 Learning projects
 - 5 Data projects
 - —The DOE Exascale Computing Project (ECP) : 15 projects
- Some projects contain multiple codes
 - -44 codes are targeted for Aurora as part of ESP or ECP projects
 - 3 codes are intended for use on the CPU only
- Involves effort from over 60 Argonne and Intel staff and over one hundred outside collaborators
- Almost all projects involve teams from outside Argonne



PVC Performance versus A100





OpenMC (courtesy of John Tramm)

https://docs.openmc.org

- OpenMC is being developed as part of the ECP ExaSMR project (PIs: Steven Hamilton, Paul Romano)
- OpenMC is a Monte Carlo particle transport code written in C++ and the OpenMP target offloading programming model
- The project seeks to accelerate the design of small modular nuclear reactors by generating virtual reactor simulation datasets with high-fidelity, coupled physics models for reactor phenomena that are truly predictive
- The Monte Carlo method employed by OpenMC is considered the "gold standard" for high-fidelity but these methods suffer from a very high computational cost.
- The extreme performance gains OpenMC has achieved on GPUs is finally bringing within reach a much larger class of problems that historically were deemed too expensive to simulate using Monte Carlo methods.



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QMCPACK (courtesy Thomas Applencourt, Ye Luo, Jeongnim Kim)

ECP Project PI: Paul Kent

- QMCPACK, is a high-performance open-source Quantum Monte Carlo (QMC) simulation code.
- Science case: computing the quantum mechanical properties of materials with benchmark accuracy, including for energy storage and quantum materials.
- QMCPACK uses C++ and OpenMP target offload, plus wrappers (eg SYCL) around vendor optimized linear algebra.



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- Running `dmc-a512-e6144-DU64` problem. This simulates a supercell of nickel oxide with 6144 electrons and 512 NiO atoms total.
- Intel® Data Center GPU Max Series: 2 MPI ranks per GPU, 8 Walkers per rank, 64 GB of HBM per stack. Using Intel(R) oneAPI DPC++/C++ Compiler 2022.12.30
- A100 (40GB): 1 MPI Rank, 7 Walkers. LLVM15 compiler. H100: llvm/clang 17, cuda 11.8): 1 MPI Rank, 7 Walkers
- The Figure Of Merit (FOM) measure is throughput (walker moves/second). Higher is better.



Final Thoughts

- Off-node communication in the form of I/O to storage or message exchange with other nodes requires some thought related to placement of the job within the network and selection of appropriate configuration on the node for tuneables and process/thread placement
- DAOS will provide a next generation level of performance for applications

—Are there ways to utilize these capabilities beyond defensive I/O





Questions?





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